

PRODUCT DATA SHEET

Sikafloor® Base 200 Therm

Self-adhesive fleece for securing Sikafloor HR Therm.

DESCRIPTION

Sikafloor® Base 200 Therm is a fleece with adhesive applied to the back for bonding to impact sound or thermal insulation laid on site as well as old substrates for decoupling. Sikafloor® Base 200 Therm enables quick and easy fixing of the Sikafloor HR Therm heating pipe to the substrate.

USES

Sikafloor® Base 200 Therm is suitable in combination with Sikafloor HR Therm and SCHÖNOX HS 50 or THOMSIT XF 700 for creating extremely thin-layer screed constructions on approved impact sound or thermal insulation underlays.

FEATURES

The following properties only apply in conjunction with the system components described below:

- Self-adhesive
- Quick and easy to use
- Low installation height
- Suitable for creating extremely thin-layer floating constructions (screed thickness 25 mm)
- Enables Sikafloor HR Therm to be fixed without clamps.
- High load-bearing capacity: Surface load 5 kN/m²
Point load 4 kN

PRODUCT INFORMATION

Fibre type	synthetic fiber
Packaging	roll
Colour	grey with installation grid
Shelf life	24 month
Storage conditions	store in a cool and dry climate
Length	20 meters
Width	1,05 meters (effectively 1 meter)
Thickness	2 milimeters

SYSTEM INFORMATION

System structure

Structures with Sikafloor® Base 200 Therm are approved with the following system components:

- Impact sound insulation requirements, see brochure
- Thermal insulation requirements, see brochure
- Sikafloor HR Therm
- SCHÖNOX HS 50
- Thomsit XF 700

System

Sikafloor® Base 200 Therm is a component of the following systems:

- SCHÖNOX RENOTHERM SYSTEM
- THOMSIT HYDRO-HEAT

BASIS OF PRODUCT DATA

All technical data stated in this Data Sheet are based on laboratory tests. Actual measured data may vary due to circumstances beyond our control.

FURTHER DOCUMENTATION

- System brochure SCHÖNOX RENOTHERM SYSTEM
- System brochure THOMSIT HYDRO HEAT SYSTEM
- Productdatasheet SCHÖNOX HS 50
- Productdatasheet THOMSIT XF 700

APPLICATION INSTRUCTIONS

SUBSTRATE QUALITY

Unevenness in the substrate must be leveled out beforehand using suitable measures, e.g., bonded fillers. Laid impact sound or thermal insulation boards must be laid flat and evenly on the substrate. When installing as decoupling on old substrates, these must be free of dust and dirt. A suitable edge insulation strip must be placed on all rising components.

APPLICATION

Sikafloor® Base 200 Therm is bonded to the substrate. To do this, remove the film from the back and bond the fleece to the substrate without wrinkles. Sikafloor® Base 200 Therm is laid with an overlap of approx. 5 cm.

LEGAL NOTES

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